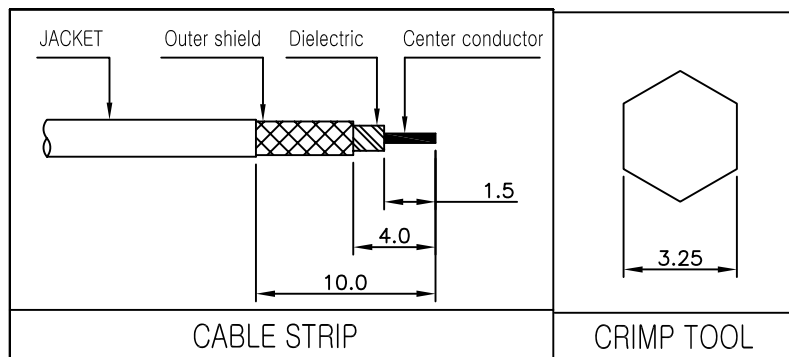
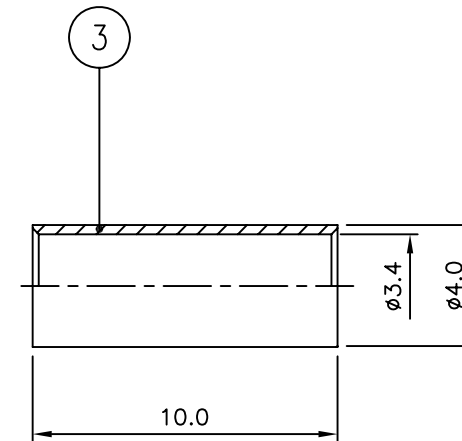
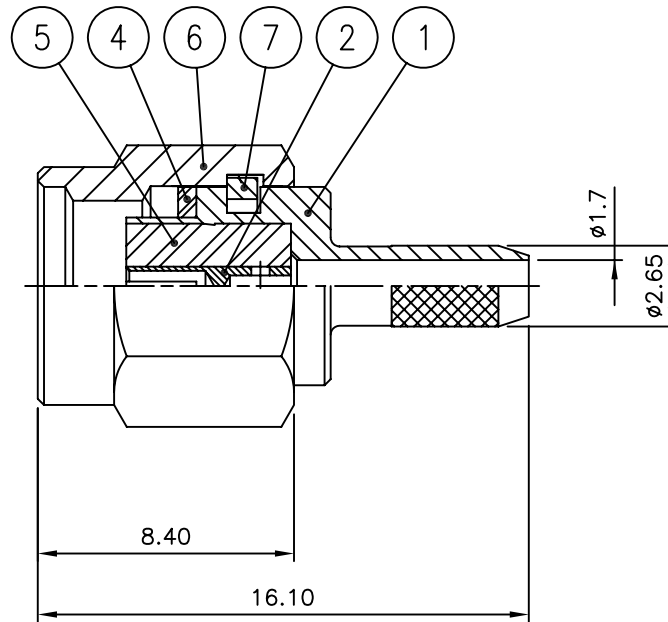


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	M.H.SONG	I.C.KIM	2013.09.11.
1	고객사 커넥터 압착부 바디 부러짐 현상 개선으로 인한 R추가	S.Y.EUN	I.C.KIM	2020.12.08.



7	SPRING RING	1	SUS	Passivate	DSR00002-5/1
6	CAP	1	MBsBD	Gold Plate	DCU00005-5/1
5	INSULATOR	1	TEFLON		DIN01667-N/1
4	GASKET	1	SILICONE Rub		DGK00004-N/1
3	FERRULE	1	MBsBD	Nickel Plate	DFE00075-5/1
2	CONTACT	1	BeCu	Gold Plate	DCT02243-5/1
1	BODY	1	MBsBD	Gold Plate	DBD00128-5/4 DBD00128-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 12. 08.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 CABLE PS(Reverse) RG316DS
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	4/1	A4 DWG NO. CN03076-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	